

10/500802

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PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of:

Masayuki OJIMA et al

National phase of International Application No. PCT/JP03/00050

International filing date: January 8, 2003

Date of entry into national phase: July 7, 2004

For: SOLDERING METHOD AND REPLENISHMENT SOLDER ALLOY

PRELIMINARY AMENDMENT

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Dear Sir:

Prior to examination, please amend the referenced  
application as shown below:

IN THE TITLE:

Please rewrite the title indicated on the front page of the international publication of the present application so as to read as follows:

~~SOLDERING METHOD AND SOLDER ALLOY FOR ADDITIONAL SUPPLY~~ SOLDERING  
METHOD AND REPLENISHMENT SOLDER ALLOY